



#9/8-1902
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Examiner: David Graybill
Group Art Unit: 2827

In re PATENT APPLICATION of:

Applicants : Mitsuru KOMIYAMA

Cont. of Appl. No. : 09/963,590

Filed : Herewith

For : MULTI-CHIP PACKAGE TYPE
SEMICONDUCTOR DEVICE

Attorney Ref.: F00ED0023-CA

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)
) **INFORMATION**
) **DISCLOSURE**
) **STATEMENT**
)
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)

June 17, 2001

Commissioner for Patents
Washington, D.C. 20231

Sir:

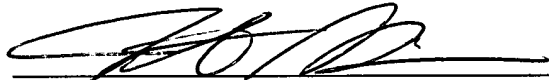
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This is an information disclosure statement submitted in compliance with the timing requirements of 37 C.F.R. §1.97(b)(1).

Attached is a copy of one U.S. patent publication. The publication is listed on the attached Form PTO-1449. Should any fee be needed, please charge it to our Account No. 50-0945 and advise us accordingly.

Consideration of the submitted documents is respectfully requested.

Respectfully submitted,



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